

Am29LV641M

64 Megabit (4 M x 16-Bit) MirrorBit™ 3.0 Volt-only Uniform Sector Flash Memory with Versatile/O™ Control

DISTINCTIVE CHARACTERISTICS

ARCHITECTURAL ADVANTAGES

- **Single power supply operation**
 - 2.7–3.6 V for read, erase, and program operations
- **Versatile/O™ control**
 - Device generates data output voltages and tolerates data input voltages as determined by the voltage on the V_{IO} pin; operates from 1.65 to 3.6 V
- **Manufactured on 0.23 µm MirrorBit process technology**
- **SecSi™ (Secured Silicon) Sector region**
 - 128-word sector for permanent, secure identification through an 8-word random Electronic Serial Number, accessible through a command sequence
 - May be programmed and locked at the factory or by the customer
- **Flexible sector architecture**
 - One hundred twenty-eight 32 Kword sectors
- **Compatibility with JEDEC standards**
 - Provides pinout and software compatibility for single-power supply flash, and superior inadvertent write protection
- **Minimum 100,000 erase cycle guarantee per sector**
- **20-year data retention at 125°C**

PERFORMANCE CHARACTERISTICS

- **High performance**
 - 90 ns access time
 - 25 ns page read times
 - 1 s typical sector erase time
 - 5.9 µs typical write buffer word programming time: 16-word write buffer reduces overall programming time for multiple-word updates

- 4-word page read buffer
- 16-word write buffer

- **Low power consumption (typical values at 3.0 V, 5 MHz)**
 - 30 mA typical active read current
 - 50 mA typical erase/program current
 - 1 µA typical standby mode current
- **Package options**
 - 48-pin TSOP

SOFTWARE & HARDWARE FEATURES

- **Software features**
 - Program Suspend & Resume: read other sectors before programming operation is completed
 - Erase Suspend & Resume: read/program other sectors before an erase operation is completed
 - Data# polling & toggle bits provide status
 - Unlock Bypass Program command reduces overall multiple-word programming time
 - CFI (Common Flash Interface) compliant: allows host system to identify and accommodate multiple flash devices
- **Hardware features**
 - Sector Group Protection: hardware-level method of preventing write operations within a sector group
 - Temporary Sector Unprotect: V_{IO}-level method of changing code in locked sectors
 - ACC (high voltage) input accelerates programming time for higher throughput during system production
 - Write Protect input (WP#) protects first or last sector regardless of sector protection settings
 - Hardware reset input (RESET#) resets device

GENERAL DESCRIPTION

The Am29LV641M is a 64 Mbit, 3.0 volt single power supply flash memory devices organized as 4,194,304 words. The devices have a 16-bit wide data bus, and can be programmed either in the host system or in standard EPROM programmers.

An access time of 90 ns is available for applications where $V_{IO} \geq 3.0$ V. An access time of 100 ns is available for applications where $V_{IO} < 3.0$ V. The device is offered in a 48-pin TSOP or 63-ball FBGA package. Each device has separate chip enable (CE#), write enable (WE#) and output enable (OE#) controls.

Each device requires only a **single 3.0 volt power supply** (2.7 V to 3.6 V) for both read and write functions. In addition to a V_{CC} input, a high-voltage **accelerated program (ACC)** input provides shorter programming times through increased current. This feature is intended to facilitate factory throughput during system production, but may also be used in the field if desired.

The device is entirely command set compatible with the **JEDEC single-power-supply Flash standard**. Commands are written to the device using standard microprocessor write timing. Write cycles also internally latch addresses and data needed for the programming and erase operations.

The **sector erase architecture** allows memory sectors to be erased and reprogrammed without affecting the data contents of other sectors. The device is fully erased when shipped from the factory.

Device programming and erasure are initiated through command sequences. Once a program or erase operation has begun, the host system need only poll the DQ7 (Data# Polling) or DQ6 (toggle) **status bits** to determine whether the operation is complete. To facilitate programming, an **Unlock Bypass** mode reduces command sequence overhead by requiring only two write cycles to program data instead of four.

The **Versatile/O™** (V_{IO}) control allows the host system to set the voltage levels that the device generates at its data outputs and the voltages tolerated at its data inputs to the same voltage level that is asserted on the

V_{IO} pin. This allows the device to operate in 1.8 V or 3 V system environment as required.

Hardware data protection measures include a low V_{CC} detector that automatically inhibits write operations during power transitions. The hardware sector protection feature disables both program and erase operations in any combination of sectors of memory. This can be achieved in-system or via programming equipment.

The **Erase Suspend/Erase Resume** feature allows the host system to pause an erase operation in a given sector to read or program any other sector and then complete the erase operation. The **Program Suspend/Program Resume** feature enables the host system to pause a program operation in a given sector to read any other sector and then complete the program operation.

The **hardware RESET# pin** terminates any operation in progress and resets the device, after which it is then ready for a new operation. The RESET# pin may be tied to the system reset circuitry. A system reset would thus also reset the device, enabling the host system to read boot-up firmware from the Flash memory device.

The device reduces power consumption in the **standby mode** when it detects specific voltage levels on CE# and RESET#, or when addresses have been stable for a specified period of time.

The **SecSi™ (Secured Silicon) Sector** provides a 128-word area for code or data that can be permanently protected. Once this sector is protected, no further changes within the sector can occur.

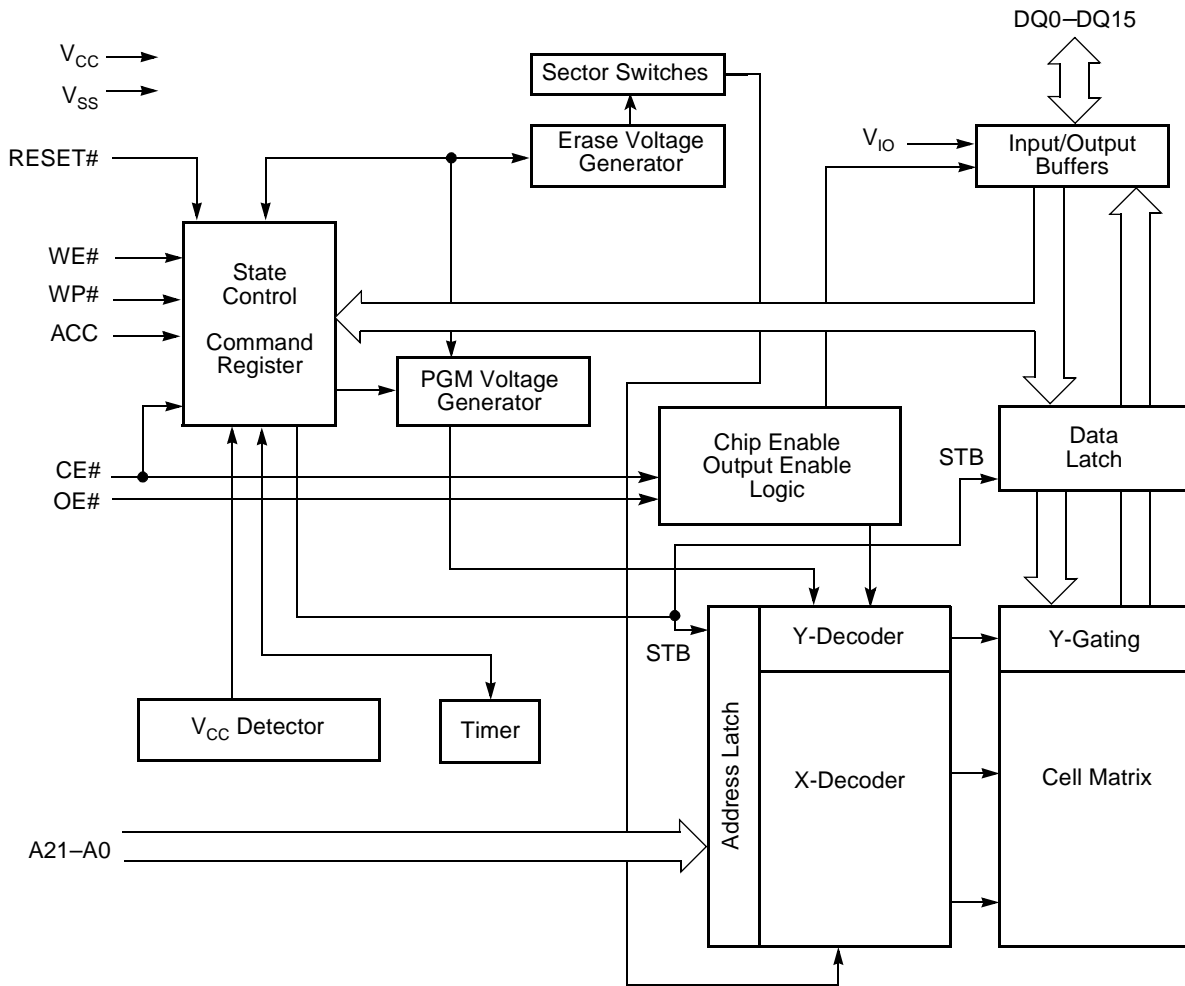
The **Write Protect (WP#)** feature protects the first or last sector by asserting a logic low on the WP# pin. The protected sector will still be protected even during accelerated programming.

AMD MirrorBit flash technology combines years of Flash memory manufacturing experience to produce the highest levels of quality, reliability and cost effectiveness. The device electrically erases all bits within a sector simultaneously via hot-hole assisted erase. The data is programmed using hot electron injection.

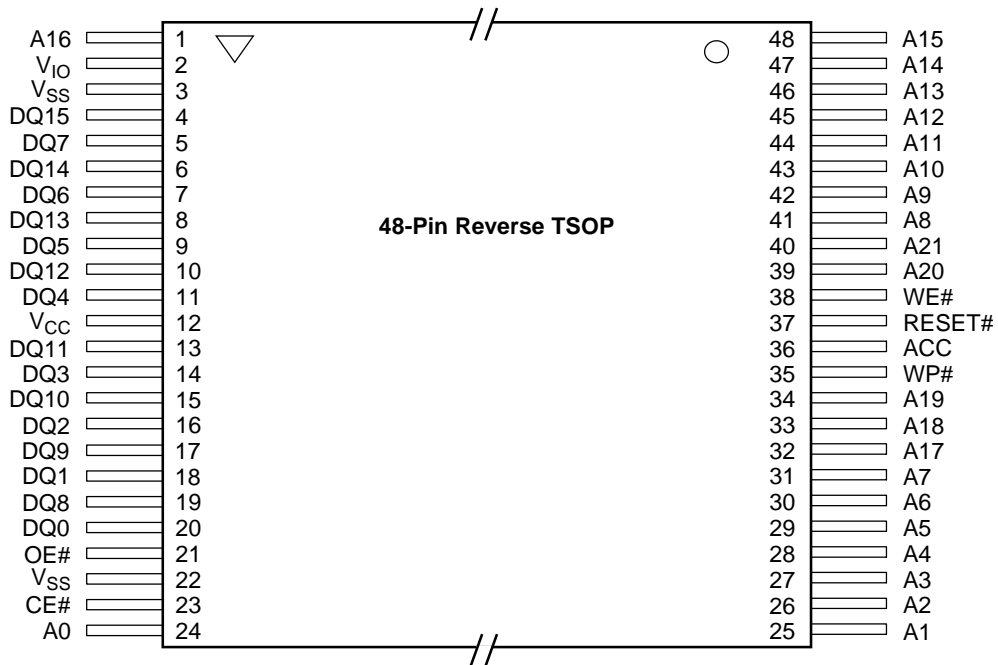
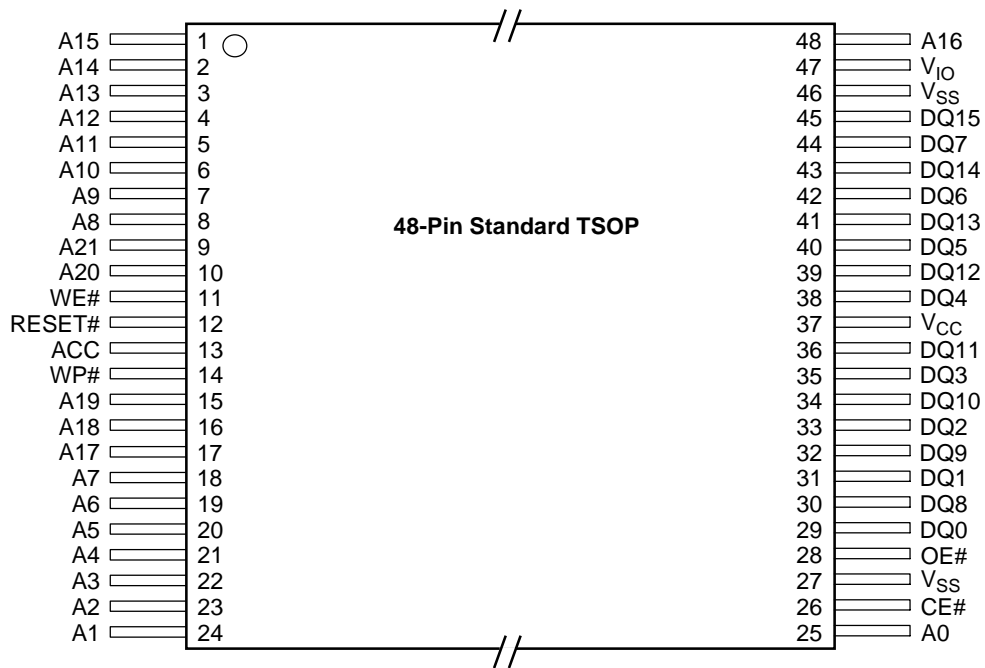
PRODUCT SELECTOR GUIDE

Part Number		Am29LV641M		
Speed Option	$V_{CC} = 2.7\text{--}3.6\text{ V}$ all devices	90 ($V_{IO} = 3.0\text{--}3.6\text{ V}$)	101 ($V_{IO} = 2.7\text{--}3.0\text{ V}$)	102 ($V_{IO} = 1.65\text{--}2.7\text{ V}$)
Max. Access Time (ns)		90	100	100
Max. CE# Access Time (ns)		90	100	100
Max. Page access time (t_{PACC})		25	30	40
Max. OE# Access Time (ns)		25	30	40

BLOCK DIAGRAM



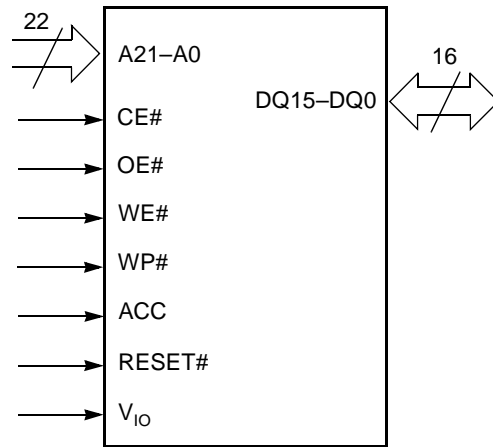
CONNECTION DIAGRAMS



PIN DESCRIPTION

- A21–A0 = 22 Addresses inputs
- DQ15–DQ0 = 16 Data inputs/outputs
- CE# = Chip Enable input
- OE# = Output Enable input
- WE# = Write Enable input
- WP# = Hardware Write Protect input
- ACC = Acceleration Input
- RESET# = Hardware Reset Pin input
- V_{CC} = 3.0 volt-only single power supply
(see Product Selector Guide for speed options and voltage supply tolerances)
- V_{IO} = Output Buffer power
- V_{SS} = Device Ground
- NC = Pin Not Connected Internally

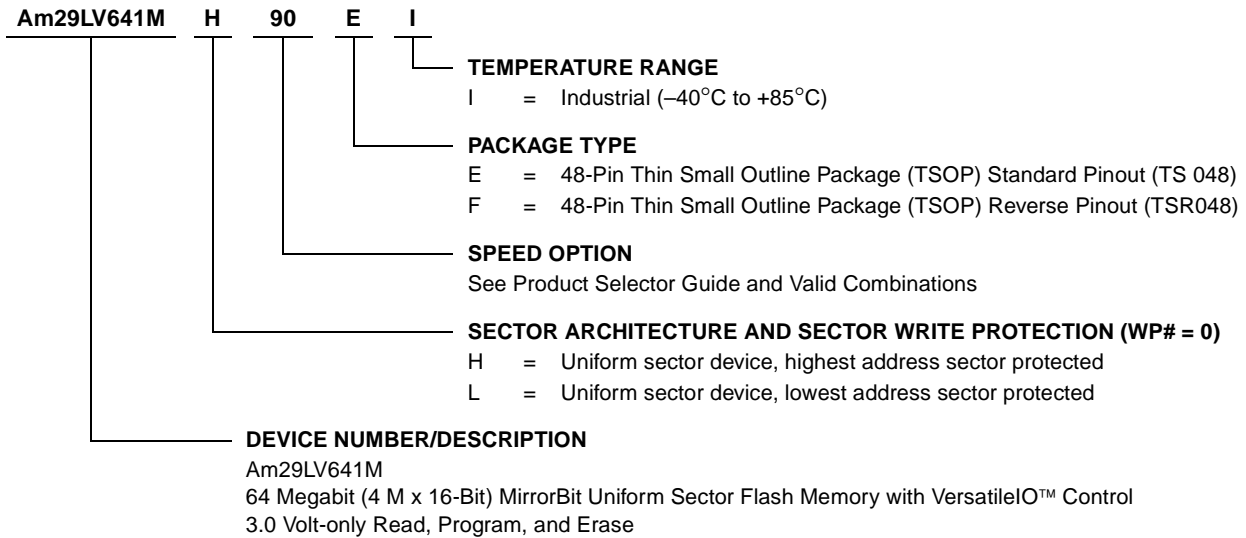
LOGIC SYMBOL



ORDERING INFORMATION

Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the following:



Valid Combinations for TSOP and SSOP Packages		Speed/V _{IO} Range
Am29LV641MH90, Am29LV641ML90	EI, FI	90 ns V _{IO} = 3.0 V – 3.6 V
Am29LV641MH101, Am29LV641ML101		100 ns V _{IO} = 2.7 V – 3.0 V
Am29LV641MH102, Am29LV641ML102		100 ns V _{IO} = 1.65 V – 2.7 V

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

REVISION SUMMARY**Revision A (August 3, 2001)**

Initial release as abbreviated Advance Information data sheet.

Trademarks

Copyright © 2001 Advanced Micro Devices, Inc. All rights reserved.

AMD, the AMD logo, and combinations thereof are registered trademarks of Advanced Micro Devices, Inc.

ExpressFlash is a trademark of Advanced Micro Devices, Inc.

Product names used in this publication are for identification purposes only and may be trademarks of their respective companies.

